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Kind regards,

Team Nexperia



# PDTD113/123/143/114EQA Series 50 V, 500 mA NPN resistor-equipped transistors

Rev. 1 — 4 February 2016

**Product data sheet** 

## **Product profile**

#### 1.1 General description

NPN Resistor-Equipped Transistor (RET) family in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

Table 1. **Product overview** 

Type number	R1	R2	Package NXP	PNP complement
PDTD113EQA	1 kΩ	1 kΩ	DFN1010D-3	PDTB113EQA
PDTD123EQA	2.2 kΩ	2.2 kΩ	(SOT1215)	PDTB123EQA
PDTD143EQA	4.7 kΩ	4.7 kΩ		PDTB143EQA
PDTD114EQA	10 kΩ	10 kΩ		PDTB114EQA

#### 1.2 Features and benefits

- 500 mA output current capability
- Built-in bias resistors
- ± 10% resistor ratio tolerance
- Simplifies circuit design
- Reduces component count
- Reduced pick and place costs
- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified

### 1.3 Applications

- Digital applications
- Cost saving alternative for BC807/BC817 series in digital applications
- Controlling IC inputs
- Switching loads

#### 1.4 Quick reference data

Table 2. Quick reference data

	• • • • • • • • • • • • • • • • • • • •					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	50	V
lo	output current		-	-	500	mA



## 2. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)		
2	GND	GND (emitter)		
3	0	output (collector)		I R1
4	0	output (collector)	4 3	GND-R2
			2	aaa-019964
			Transparent top view	

## 3. Ordering information

Table 4. Ordering information

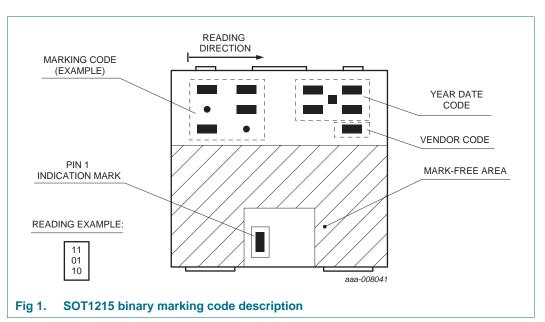
Type number	Package					
	Name	Description	Version			
PDTD113EQA	DFN1010D-3	plastic thermal enhanced ultra thin small outline	SOT1215			
PDTD123EQA		package; no leads; 3 terminals; body: 1.1 × 1.0 × 0.37 mm				
PDTD143EQA						
PDTD114EQA						

## 4. Marking

Table 5. Marking codes

Type number	Marking code
PDTD113EQA	01 00 11
PDTD123EQA	01 01 10
PDTD143EQA	01 10 01
PDTD114EQA	01 11 01

## 4.1 Binary marking code description



## 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

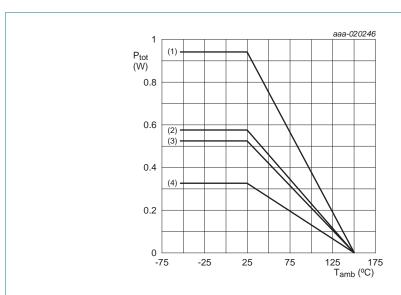
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	50	V
$V_{CEO}$	collector-emitter voltage	open base	-	50	V
$V_{EBO}$	emitter-base voltage	open collector	-	10	V

 Table 6.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		·		·
	PDTD113EQA		-10	+10	V
	PDTD123EQA		-10	+12	V
	PDTD143EQA		-10	+30	V
	PDTD114EQA		-10	+50	V
Io	output current		-	500	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1] -	325	mW
			[2] _	575	mW
			[3]	525	mW
			<u>[4]</u> _	940	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.
- [4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



- (1) FR4 PCB, 4-layer copper, 1 cm<sup>2</sup>
- (2) FR4 PCB, single-sided copper, 1 cm<sup>2</sup>
- (3) FR4 PCB, 4-layer copper, standard footprint
- (4) FR4 PCB, single sided copper, standard footprint

Fig 2. Power derating curves

#### 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction	in free air	<u>[1]</u>	-	-	385	K/W
	to ambient	[2]	[2]	-	-	218	K/W
		-	[3]	-	-	239	K/W
		-	[4]	-	-	133	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	40	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.
- [4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

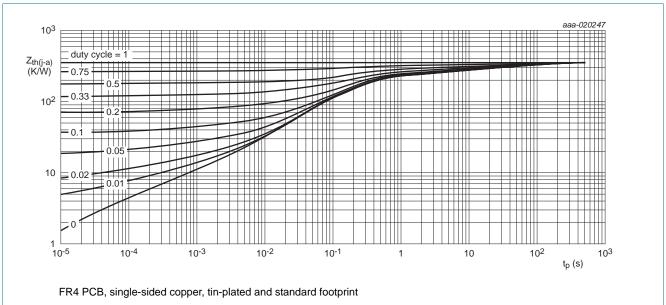
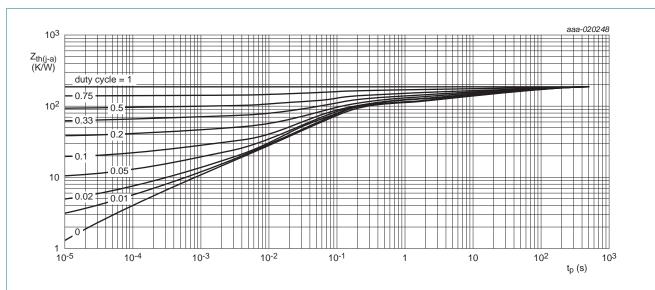
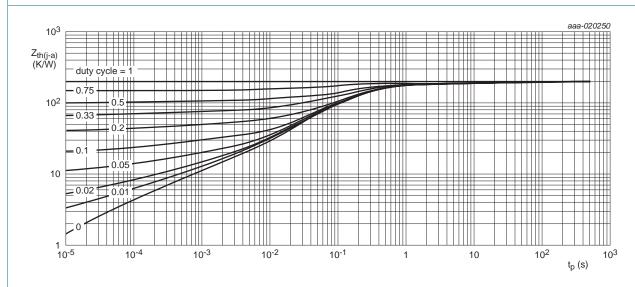


Fig 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



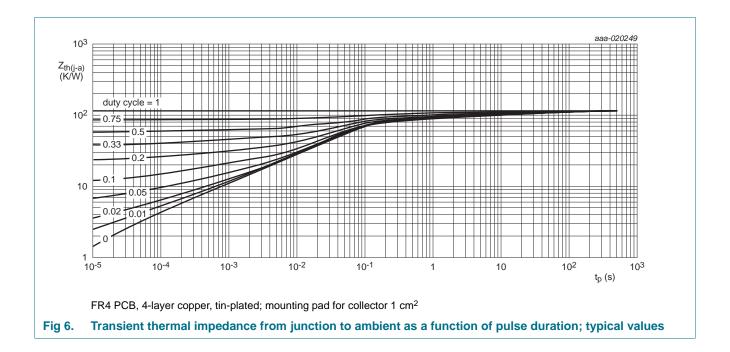
FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>

Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, tin-plated and standard footprint

Fig 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



## 7. Characteristics

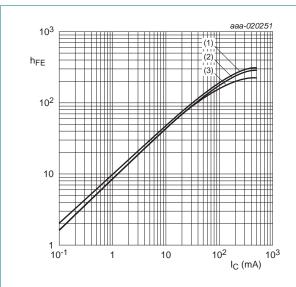
Table 8. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
I <sub>CEO</sub>	collector-emitter cut-off current	$V_{CE} = 50 \text{ V}; I_{B} = 0 \text{ A}$	-	-	0.5	μΑ
I <sub>EBO</sub>	emitter-base cut-off curr	ent				'
	PDTD113EQA	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A	-	-	4	mA
	PDTD123EQA		-	-	2	mA
	PDTD143EQA		-	-	0.9	mA
	PDTD114EQA				0.4	mA
h <sub>FE</sub>	DC current gain					'
	PDTD113EQA	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 50 mA	33	-	-	
	PDTD123EQA		40	-	-	
	PDTD143EQA		60	-	-	
	PDTD114EQA		70	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 50 \text{ mA}; I_B = 2.5 \text{ mA}$	-	-	100	mV
V <sub>I(off)</sub>	off-state input voltage					
	PDTD113EQA PDTD123EQA	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$	0.6	1.05	1.5	V
			0.6	1.05	1.8	V
	PDTD143EQA		0.6	1.05	1.5	V
	PDTD114EQA			1.05	1.5	V
V <sub>I(on)</sub>	on-state input voltage					
	PDTD113EQA	$V_{CE} = 0.3 \text{ V}; I_{C} = 20 \text{ mA}$	1	1.45	1.8	V
	PDTD123EQA		1	1.5	2	V
	PDTD143EQA		1	1.7	2.2	V
	PDTD114EQA		1	2.2	3	V
R1	bias resistor 1 (input)	[1]				
	PDTD113EQA		0.7	1	1.3	kΩ
	PDTD123EQA		1.54	2.2	2.86	kΩ
	PDTD143EQA		3.3	4.7	6.1	kΩ
	PDTD114EQA		7	10	13	kΩ
R2/R1	bias resistor ratio	<u>[1]</u>	0.9	1	1.1	
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	5	-	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 50 mA; f = 100 MHz	-	210	-	MHz

<sup>[1]</sup> See section test information for resistor calculation and test conditions.

<sup>[2]</sup> Characteristics of built-in transistor.



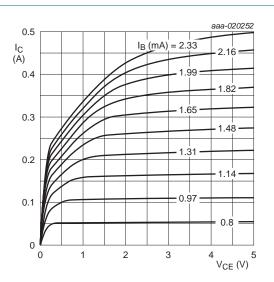
 $V_{CE} = 5 V$ 

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

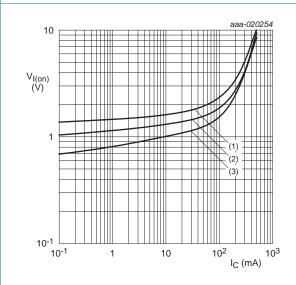
(3)  $T_{amb} = -40 \, ^{\circ}C$ 





T<sub>amb</sub> = 25 °C

Fig 8. PDTD113EQA: Collector current as a function of collector-emitter voltage; typical values



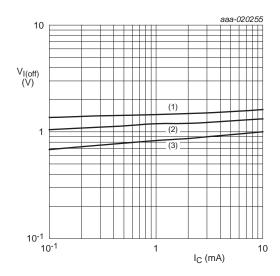
 $V_{CE} = 0.3 \text{ V}$ 

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3)  $T_{amb} = 100 \, ^{\circ}C$ 

Fig 9. PDTD113EQA: On-state input voltage as a function of collector current; typical values



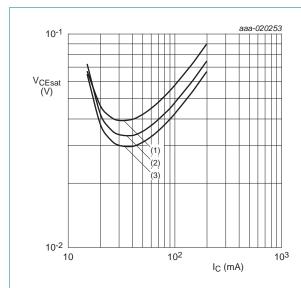
 $V_{CE} = 5 V$ 

(1) 
$$T_{amb} = -40 \, ^{\circ}C$$

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

(3)  $T_{amb} = 100 \, ^{\circ}C$ 

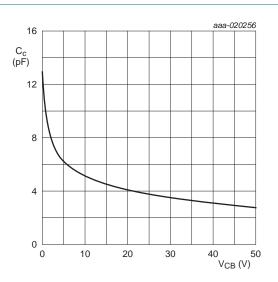
Fig 10. PDTD113EQA: Off-state input voltage as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 20$ 

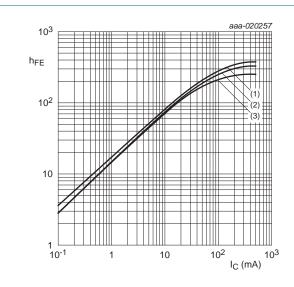
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 11. PDTD113EQA: Collector-emitter saturation voltage as a function of collector current; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

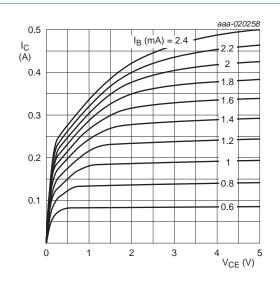
Fig 12. PDTD113EQA: Collector capacitance as a function of collector-base voltage; typical values



 $V_{CE} = 5 V$ 

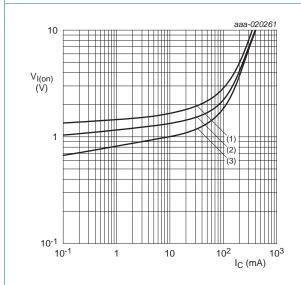
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 13. PDTD123EQA: DC current gain as a function of collector current; typical values



T<sub>amb</sub> = 25 °C

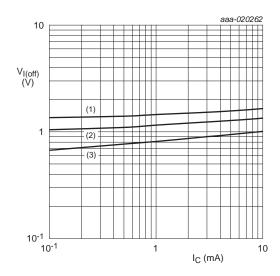
Fig 14. PDTD123EQA: Collector current as a function of collector-emitter voltage; typical values





- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

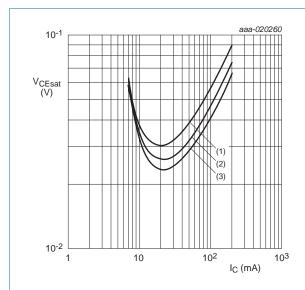
Fig 15. PDTD123EQA: On-state input voltage as a function of collector current; typical values



 $V_{CE} = 5 V$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

Fig 16. PDTD123EQA: Off-state input voltage as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 20$ 

- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 17. PDTD123EQA: Collector-emitter saturation voltage as a function of collector current; typical values

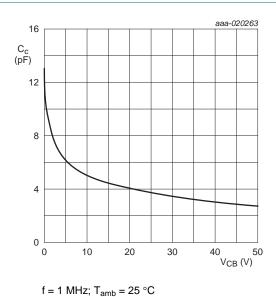
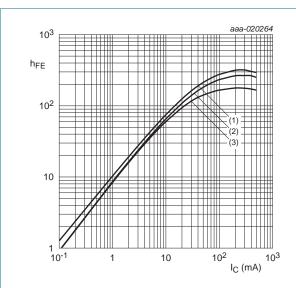


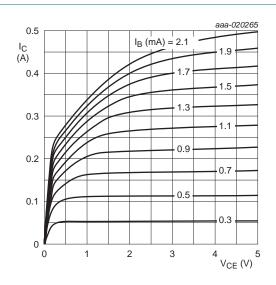
Fig 18. PDTD123EQA: Collector capacitance as a function of collector-base voltage; typical values



 $V_{CE} = 5 V$ 

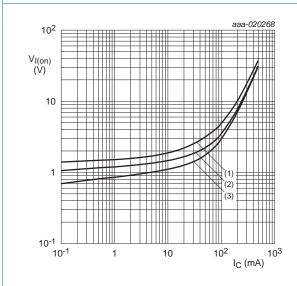
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 19. PDTD143EQA: DC current gain as a function of collector current; typical values



T<sub>amb</sub> = 25 °C

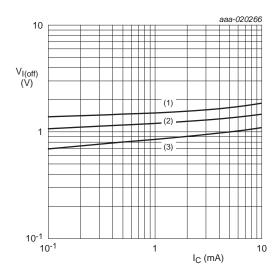
Fig 20. PDTD143EQA: Collector current as a function of collector-emitter voltage; typical values





- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

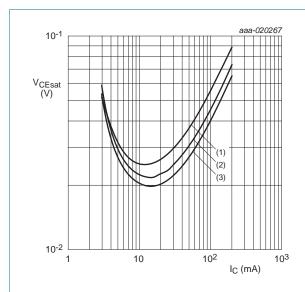
Fig 21. PDTD143EQA: On-state input voltage as a function of collector current; typical values



 $V_{CE} = 5 V$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

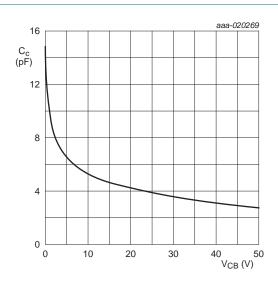
Fig 22. PDTD143EQA: Off-state input voltage as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 20$ 

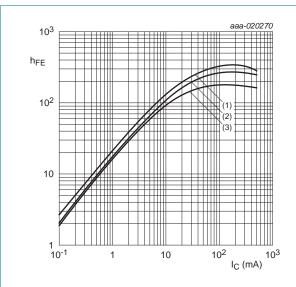
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 23. PDTD143EQA: Collector-emitter saturation voltage as a function of collector current; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig 24. PDTD143EQA: Collector capacitance as a function of collector-base voltage; typical values



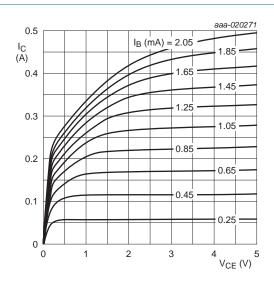
 $V_{CE} = 5 V$ 

(1)  $T_{amb} = 100 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

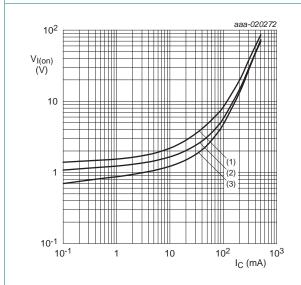
(3)  $T_{amb} = -40 \, ^{\circ}C$ 

Fig 25. PDTD114EQA: DC current gain as a function of collector current; typical values



T<sub>amb</sub> = 25 °C

Fig 26. PDTD114EQA: Collector current as a function of collector-emitter voltage; typical values



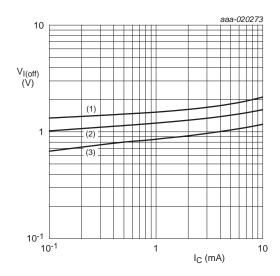
 $V_{CE} = 0.3 \text{ V}$ 

(1)  $T_{amb} = -40 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

(3) T<sub>amb</sub> = 100 °C

Fig 27. PDTD114EQA: On-state input voltage as a function of collector current; typical values



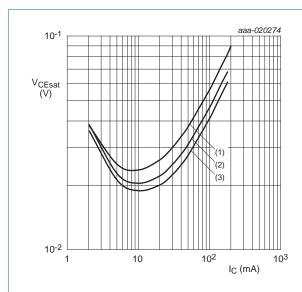
 $V_{CE} = 5 V$ 

(1)  $T_{amb} = -40 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

(3)  $T_{amb} = 100 \, ^{\circ}C$ 

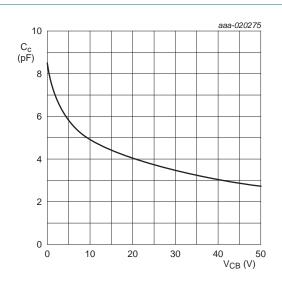
Fig 28. PDTD114EQA: Off-state input voltage as a function of collector current; typical values



 $I_C/I_B = 20$ 

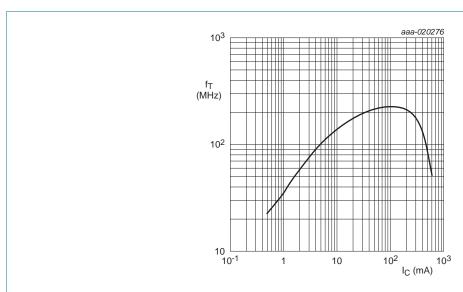
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 29. PDTD114EQA: Collector-emitter saturation voltage as a function of collector current; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig 30. PDTD114EQA: Collector capacitance as a function of collector-base voltage; typical values



 $V_{CE} = 5 \text{ V}; f = 100 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig 31. Transition frequency as a function of collector current; typical values of built-in transistor

#### 8. Test information

#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

#### 8.2 Resistor calculation

• Calculation of bias resistor 1 (R1):

$$R1 = \frac{V(I_{I2}) - V(I_{I1})}{I_{I2} - I_{I1}}$$

• Calculation method A of bias resistor ratio (R2/R1):

$$\frac{R2}{R1} = \frac{V(I_{I3})}{R1 \cdot I_{I3}} - 1$$

• Calculation method B of bias resistor ratio (R2/R1):

$$\frac{R2}{RI} = \frac{V(I_{I4}) - V(I_{I3})}{RI \cdot (I_{I4} - I_{I3})} - 1$$

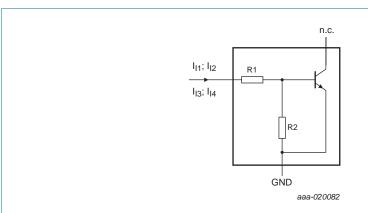


Fig 32. Resistor test circuit

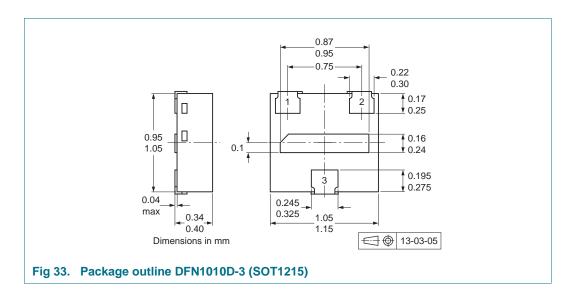
#### 8.3 Resistor test conditions

Table 9. Resistor test conditions

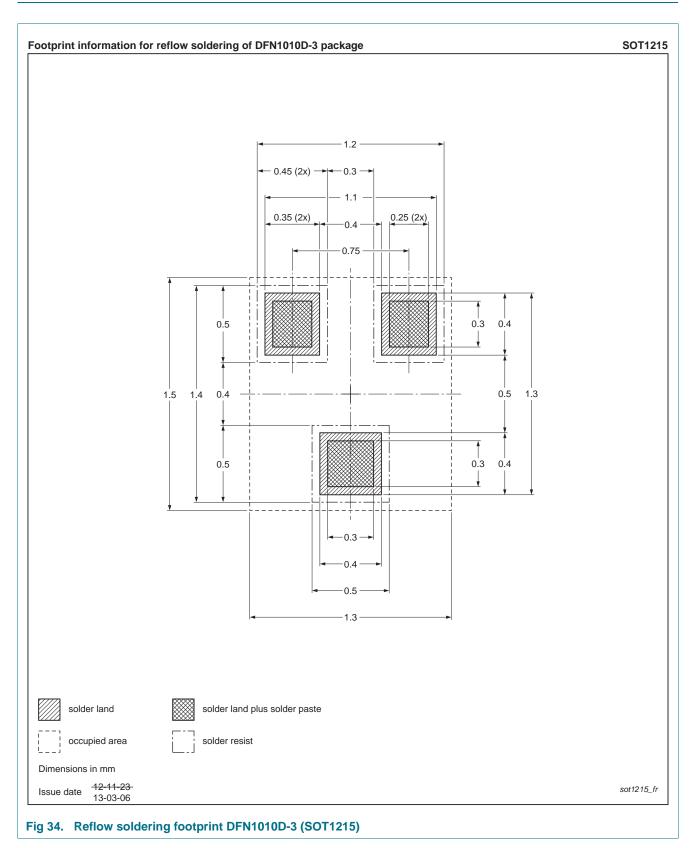
Type number		R1	R2	Test cond			
		kΩ	kΩ	I <sub>I1</sub>	l <sub>l2</sub>	I <sub>I3</sub>	I <sub>14</sub>
PDTD113EQA	<u>[1]</u>	1	1	1.5 mA	1.9 mA	–2.2 mA	-
PDTD123EQA	<u>[1]</u>	2.2	2.2	0.7 mA	0.8 mA	−0.75 mA	-
PDTD143EQA	[2]	4.7	4.7	1.3 mA	1.5 mA	-1.05 mA	-1.25 mA
PDTD114EQA	[2]	10	10	0.7 mA	0.8 mA	−0.45 mA	-0.55 mA

- [1] Uses calculation method A of bias resistor ratio R2/R1
- [2] Uses calculation method B of bias resistor ratio R2/R1

## 9. Package outline



## 10. Soldering



PDTD113\_123\_143\_114EQA\_SER

## PDTD113/123/143/114EQA

50 V, 500 mA NPN resistor-equipped transistors

## 11. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTD113_123_143_114EQA_SER	20160104	Product data sheet	-	-
v.1				

## 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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## PDTD113/123/143/114EQA

#### 50 V, 500 mA NPN resistor-equipped transistors

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